# 2SB0709A (2SB709A)

### Silicon PNP epitaxial planer type

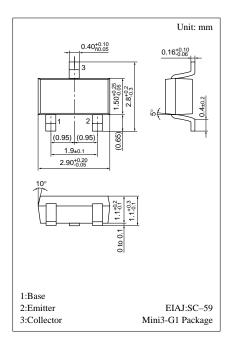
For general amplification
Complementary to 2SD0601A (2SD601A)

#### Features

- High foward current transfer ratio h<sub>FE</sub>.
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

#### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	-45	V
Collector to emitter voltage	$V_{CEO}$	-45	V
Emitter to base voltage	$V_{\rm EBO}$	-7	V
Peak collector current	$I_{CP}$	-200	mA
Collector current	$I_{C}$	-100	mA
Collector power dissipation	$P_{C}$	200	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	$T_{stg}$	<b>−55</b> ~ <b>+150</b>	°C



#### Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = -20V, I_E = 0$			- 0.1	μΑ
	$I_{CEO}$	$V_{CE} = -10V, I_{B} = 0$			-100	μΑ
Collector to base voltage	$V_{CBO}$	$I_{C} = -10\mu A, I_{E} = 0$	-45			V
Collector to emitter voltage	$V_{CEO}$	$I_{\rm C} = -2mA, I_{\rm B} = 0$	-45			V
Emitter to base voltage	$V_{EBO}$	$I_E = -10\mu A, I_C = 0$	-7			V
Forward current transfer ratio	h <sub>FE</sub> *	$V_{CE} = -10V, I_{C} = -2mA$	160		460	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -100 \text{mA}, I_B = -10 \text{mA}$		- 0.3	- 0.5	V
Transition frequency	$f_T$	$V_{CB} = -10V, I_E = 1mA, f = 200MHz$		80		MHz
Collector output capacitance	$C_{ob}$	$V_{CB} = -10V$ , $I_E = 0$ , $f = 1MHz$		2.7		pF

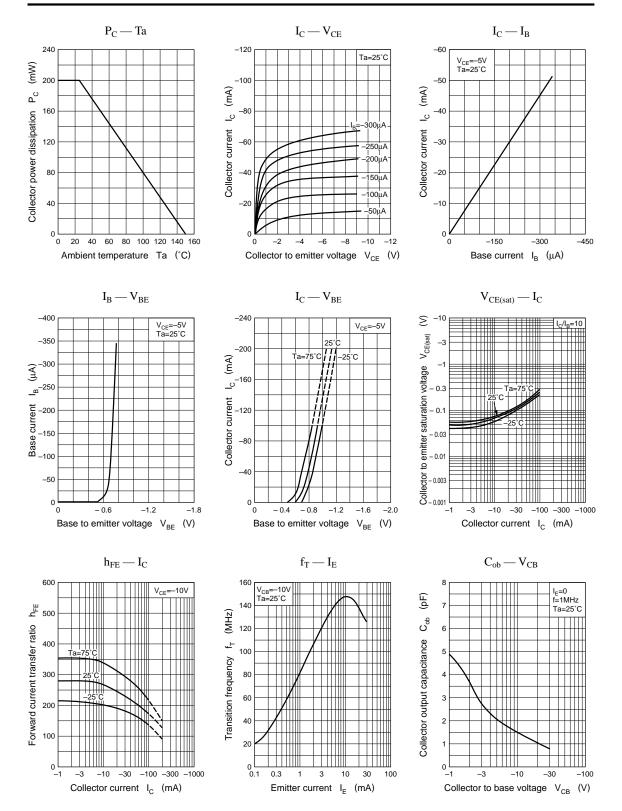
#### \*1hFE Rank classification

Rank	Q	R	S
$h_{FE}$	160 ~ 260	210 ~ 340	290 ~ 460
Marking Symbol	BQ	BR	BS

Note.) The Part number in the Parenthesis shows conventional part number.

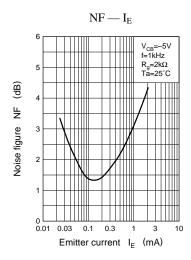
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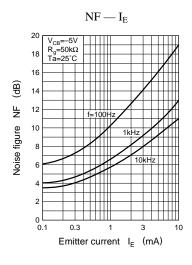
Transistor 2SB0709A

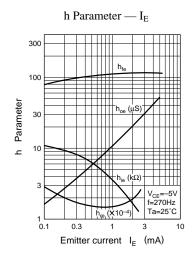


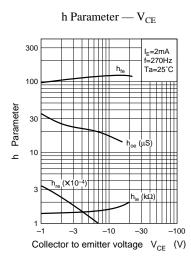
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Transistor 2SB0709A









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